

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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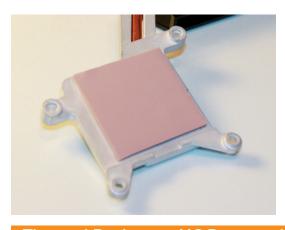




TG6050

Ultra Soft Thermal Conductive Pad





Features

Superior thermal conductivity Highly compressible Naturally tacky Low Shore 00 hardness Low oil bleed Electrically insulating

Applications

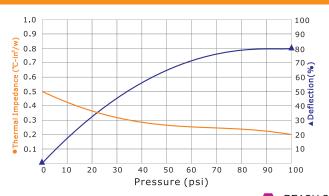
Electronic components: IC / CPU / MOS

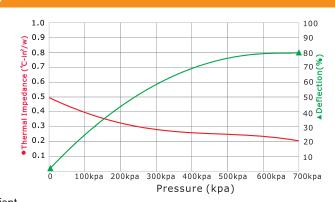
 $\verb| LED / M/B / P/S / Heat Sink / LCD-TV / Notebook PC / PC / Telecom Device / \\$

Wireless Hub etc....

DDR II Module / DVD Applications / Hand-Set applications etc...

Thermal Resistance V.S Pressure V.S Deflection





Properties

Thermal Conductivity: 6.0 W/mK

(W/mK - Z Axis)

REACH CompliantRoHS Compliant

Hardness: 50 (Shore 00)

(Shore 00)

0 0.8 1.2 1.4 1.6 1.7 1.8 2.2 3.2 3.6 4.0 4.5 5.0 15 20

0 5 10 15 20 25 30 40 80

Testing sample thickness: 1.0 mm

In the thermal resistance vs pressure vs deflection charts TG6050 provides low thermal impedance. As the pressure increases the thermal impedance decreases. TG6050 provides good compliance and softness.

Property	TG6050	Unit	Tolerance	Test Method
Colour	Red	-	-	Visual
Thickness (Available thickness range)	0.5 - 2.0	mm	-	ASTM D374
	0.0197 - 0.0787	inch	-	ASTM D374
Thermal Conductivity	6	W/mK	-	ASTM D5470
Flammability Rating	V-0	-	-	UL 94
Dielectric Breakdown Voltage	13	kV/mm	-	ASTM D149
Weight Loss	< 1	%	-	ASTM E595
Specific Gravity	3.2	g/cm³	±0.2	ASTM D792
Working Temperature	-45 to 200	°C	-	-
Volume Resistance	>10 ¹²	Ohm-cm	-	ASTM D257
Elongation	50	%	±13	ASTM D412
Tensile Strength	0.5	Kgf/cm²	±2	ASTM D412
Standard Shape	-	Sheets 320-320mm	-	-
Hardness	50	Shore 00	±5	ASTM D2240

Available with an adhesive backing

